Application Report
SLUA755 – July 2015

bq40z50 to bq40z50-R1 Change List

Battery Management

ABSTRACT

This document describes the changes made from bq40z50 to bq40z50-R1. The latest ordering information and data sheet is available on the TI Web site.

INTRODUCTION

bq40z50-R1 firmware version 1.06 has been released to enable several feature additions and performance improvements. The following new orderable part numbers have been released which ship pre-programmed with this new version of firmware:

- bq40z50RSMT-R1
- bq40z50RSMR-R1

To work with bq40z50-R1, download the latest version of Battery Management Studio (bqStudio) evaluation software from ti.com.

The existing bq40z50 ICs and EVMs can be upgraded to bq40z50-R1 FW.

CHANGE DETAILS

Table 1. Change Details

CHANGE	bq40z50-R1	bq40z50	Comments
No Load Reserve capacity	New feature introduced to work with bq2961xy LDO integrated protector	Feature does not exist	Feature allows to input reserve capacity after RSOC reaches 0% for powering the RTC circuit via the LDO in bq2961xy
Clamp Current	If measured current exceeds Max value, the current is clamped to max value in the discharge direction	In the discharge direction, if current <= -32768mA, then it is reported as 0mA.	Current is clamped to max value and prevents roll over
Term V Hold	Remaining capacity reports 0% after voltage stays below termination for Term V Hold time.	Feature does not exist	Avoids RSOC reporting 0% from a short high dsg current pulse driving voltage below termination voltage momentarily
PF Shutdown	Device enters shutdown in Permanent failure mode when battery voltage is less than configurable threshold	Feature does not exist	Minimizes power consumption and avoids draining the battery further
ManufacturerStatus()[CAL]	ManufacturerStatus()[CAL] bit is set when Manufacturing Status Init is zero at power on reset	ManufacturerStatus()[CAL] bit is not set	Features added for ease of customer production line processing
Constant FCC during charge	FCC remains stable without changes in Charge mode	FCC can change in Charge mode	Supports Windows OS requirement of FCC remaining stable in Charge mode
4-Byte block read/write	4-byte block read/write available in gauge SEALED mode	Feature does not exist	Feature added to support Microsoft BIOS requirements
Algorithm Robustness	Several algorithm robustness improvements	Improvements do not exist	Helps with smoother/accurate reporting of SOC/FCC

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as “components”) are sold subject to TI’s terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI’s terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers’ products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers’ products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI’s goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or “enhanced plastic” are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have ***not*** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products		**Applications**	
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Security	www.ti.com/security
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Applications Processors	www.ti.com/omap	**TI E2E Community**	e2e.ti.com
Wireless Connectivity	www.ti.com/wirelessconnectivity		

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2015, Texas Instruments Incorporated